



General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

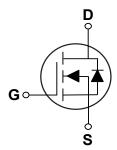
BV _{DSS}	R _{DS(ON)}	Ι _D
85 V	5.6 mΩ	100 A

Features

- $R_{DS(ON)} \le 5.6 m\Omega @V_{GS} = 10V$
- Improved dv/dt Capability
- · Fast Switching
- · Green Device Available

PPAK5X6 Pin Configuration





Applications

- · Battery Management System
- · Power Management Switching
- Motor Drive

Absolute Maximum Ratings T _A =25°C unless otherwise noted					
Symbol	Parameter	Rating	Units		
V _{DS}	Drain-Source Voltage	85	V		
V_{GS}	Gate-Source Voltage	±20	V		
1	Drain Current – Continuous (T _C =25°C)	100	Α		
I _D	Drain Current – Continuous (T _C =100°C)	63.3	Α		
I _{DM}	Drain Current – Pulsed (NOTE 1)	400	Α		
EAS	Single Pulse Avalanche Energy (NOTE 2)	273.8	mJ		
P _D	Power Dissipation (T _C =25°C)	107.8	W		
T_J	Operating Junction Temperature	150	°C		
T _{STG}	Storage Temperature Range	-55 to 150	°C		
Marking Code		NK5P6			

Thermal Characteristics					
Symbol Parameter Rating		Unit			
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	60	°C/W		
$R_{ heta JC}$	Thermal Resistance Junction to Case	1.16	°C/W		





Electrical Characteristics (T_{.1}=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	85			V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =85V , V_{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A			5.6	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	2		4	V
g _{fs}	Forward Transconductance	V_{DS} =5V , I_{D} =20A		57.8		S

Dynamic and switching Characteristics (NOTE 4)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge			61.3		
Q_gs	Gate-Source Charge	V_{DS} =40V , V_{GS} =10V , I_{D} =20A	-	21		nC
Q_{gd}	Gate-Drain Charge		-	11		
$T_{d(on)}$	Turn-On Delay Time		-	16.5		
T _r	Rise Time	V_{DD} =40V , V_{GS} =10V , R_{G} =3 Ω ,		51.8		nS
$T_{d(off)}$	Turn-Off Delay Time	I _D =20A		37.1		113
T_f	Fall Time		-	8.2		
C _{iss}	Input Capacitance			4645		
C_{oss}	Output Capacitance	V_{DS} =40V , V_{GS} =0V , F=1MHz		673		pF
C_{rss}	Reverse Transfer Capacitance			41		
R_g	Gate Resistance	V_{GS} =0V , V_{DS} =0V , F=1MHz		2		Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{SD}	Diode Forward Voltage (NOTS 3)	V_{GS} =0V , I_S =20A			1.2	V

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, V_{GS} =10V, L=0.4mH, I_{AS} =37A.
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Guaranteed by design, not subject to production testing.





Characteristics Curves

FIG. 1 - Drain Current

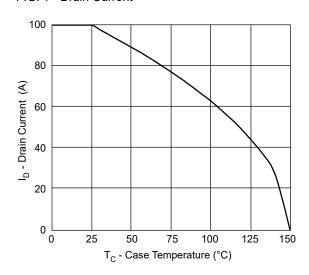


FIG. 2 - Gate Threshold Voltage

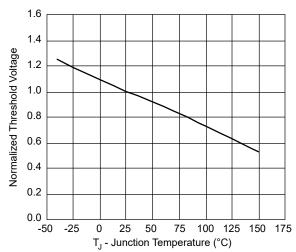


FIG. 3 - Source-Drain Diode Forward

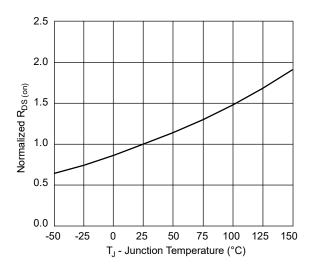


FIG. 4 - Gate Charge Characteristics

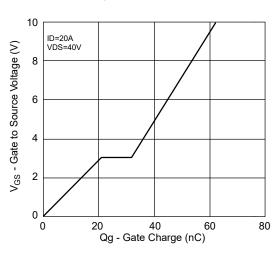


FIG. 5 - Safe Operating Area

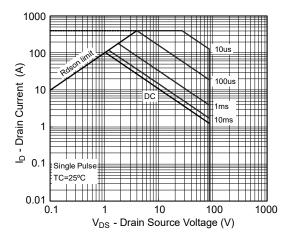
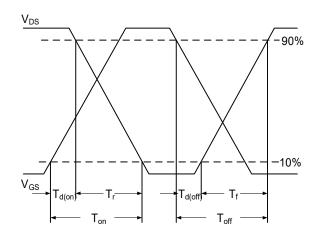


FIG. 6 - Switching Time Waveform

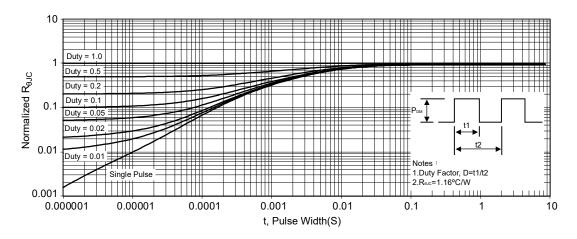




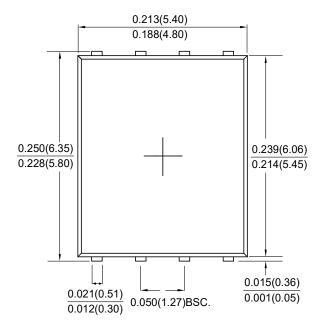


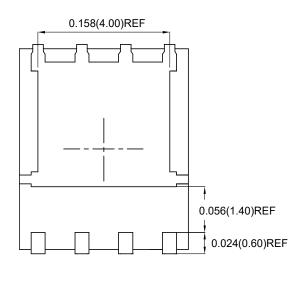
Characteristics Curves

FIG. 7 - Normalized Transient Thermal Impedance



Package Outline Dimensions









PPAK5X6

Dimensions in inches and (millimeters)





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